

500V N-Channel MOSFET

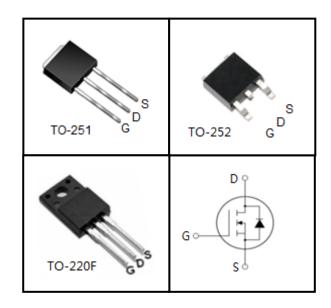
FEATURES

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

Device Marking and Package Information				
Device	Package	Marking		
CST08N50U	TO-251	CST08N50U		
CST08N50D	TO-252	CST08N50D		
CST08N50F	TO-220F	CST08N50F		



Absolute Maximum Ratings $T_c = 25^{\circ}C$, unless otherwise noted						
Parameter	Symbol	Value			Unit	
raiametei		TO-220F	TO-251	TO-252		
Drain-Source Voltage ($V_{GS} = 0V$)	V _{DSS}		500		V	
Continuous Drain Current	I _D		0.8		А	
Pulsed Drain Current (note1)	I _{DM}	3.2			А	
Gate-Source Voltage	V _{GSS}		±30		V	
Single Pulse Avalanche Energy (note2)	E _{AS}	3.2		mJ		
Avalanche Current (note1)	I _{AS}	0.8		А		
Repetitive Avalanche Energy (note1)	E _{AR}	1.9		mJ		
Power Dissipation ($T_c = 25^{\circ}C$)	P _D	12		15	W	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150		°C		

Thermal Resistance					
Parameter	Symbol	Value			Unit
		TO-220F	TO-251	TO-252	Onit
Thermal Resistance, Junction-to-Case	R_{thJC}	10.3	8.3		°C/W
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62.5	60		



CST08N50U, CST08N50D,CST08N50F

Specifications $T_J = 25^{\circ}C$, unless otherwise noted								
Parameter	Symbol	Test Conditions	Value			Unit		
	Symbol	Test conditions	Min.	Тур.	Max.	Unit		
Static								
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250 \mu A$	500			V		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 500V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μA		
Gate-Source Leakage	I _{GSS}	V_{GS} = $\pm 25V$			±100	nA		
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.2		3.2	V		
Drain-Source On-Resistance (Note3)	$R_{DS(on)}$	$V_{GS} = 10V, I_{D} = 0.35A$		12	15	Ω		
Dynamic								
Input Capacitance	C _{iss}	V _{GS} = 0V,		83		pF		
Output Capacitance	C _{oss}	$V_{DS} = 25V,$		10				
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		1				
Total Gate Charge	Q _g			4.5		nC		
Gate-Source Charge	Q_{gs}	$V_{DD} = 400V, I_D = 0.7A, V_{GS} = 10V$		0.55				
Gate-Drain Charge	Q_{gd}			2.6				
Turn-on Delay Time	t _{d(on)}			32				
Turn-on Rise Time	t _r	V _{DD} = 250V, I _D = 0.7A,		7.9		ns		
Turn-off Delay Time	t _{d(off)}	$R_{\rm G} = 25 \ \Omega$		43				
Turn-off Fall Time	t _f			42				
Drain-Source Body Diode Character	istics			-				
Continuous Body Diode Current	۱ _s				0.8	А		
Pulsed Diode Forward Current	I _{SM}	T _C = 25 °C			3.2			
Body Diode Voltage	V _{SD}	$T_J = 25^{\circ}C, I_{SD} = 0.35A, V_{GS} = 0V$			1.4	V		
Reverse Recovery Time	t _{rr}	V _{GS} = 0V,I _S = 0.7A,		468		ns		
Reverse Recovery Charge	Q _{rr}	di _F /dt = 100A /µs		221		nC		

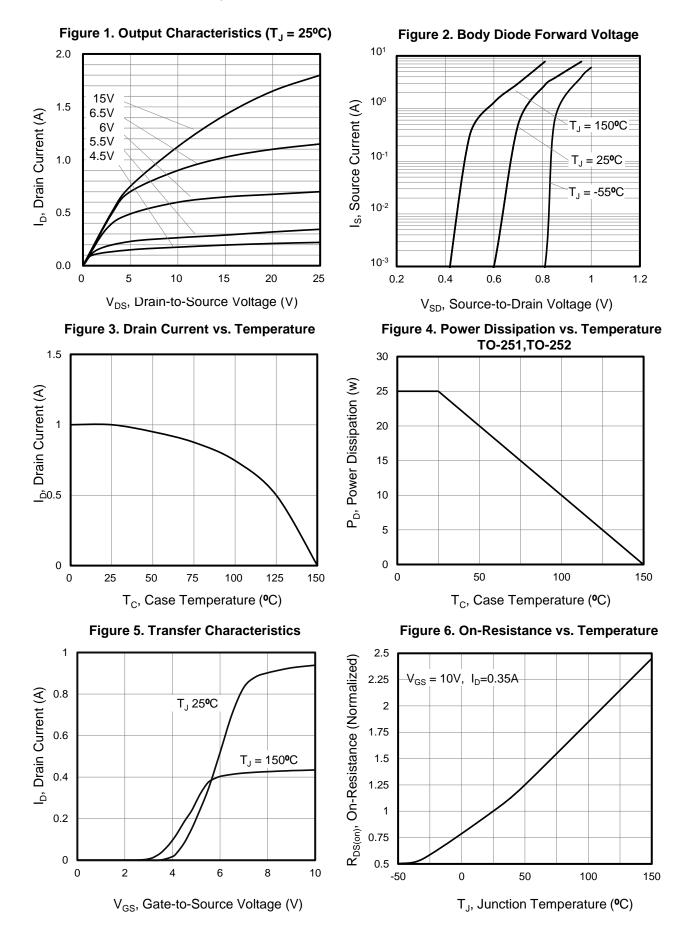
Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L=10mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 °C
- 3. Pulse Test: Pulse width \leq 300µs, Duty Cycle \leq 1%



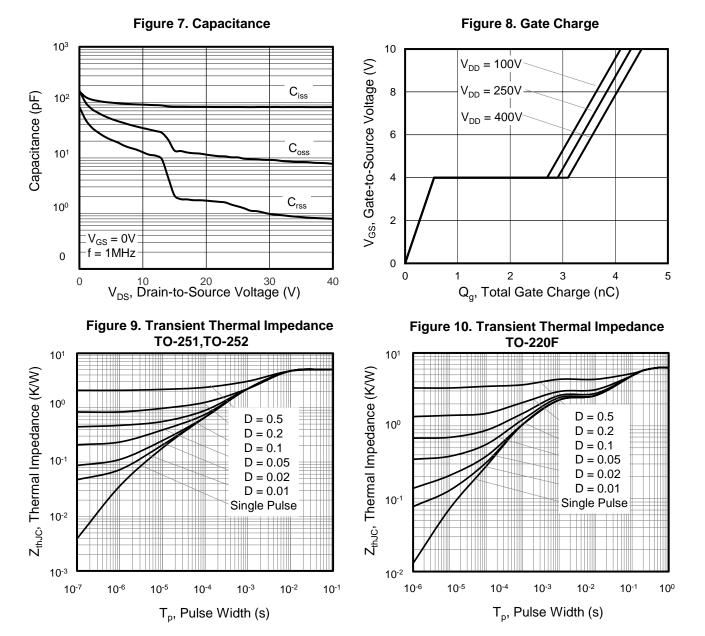
CST08N50U, CST08N50D, CST08N50F

Typical Characteristics T_J = 25°C, unless otherwise noted





Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted





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Figure A: Gate Charge Test Circuit and Waveform

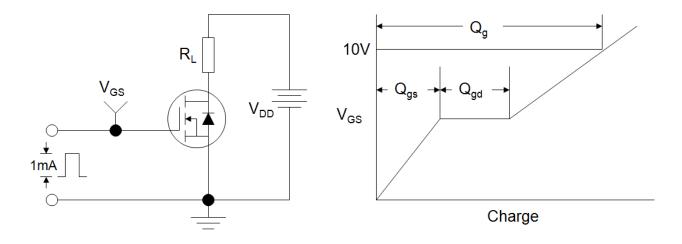


Figure B: Resistive Switching Test Circuit and Waveform

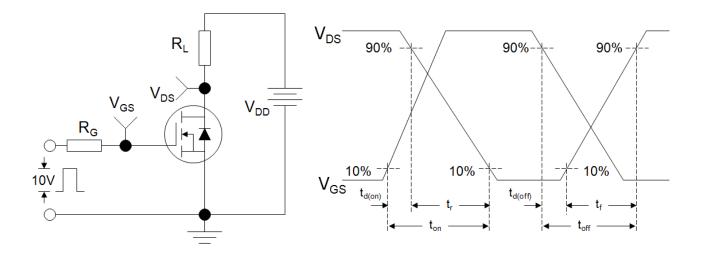
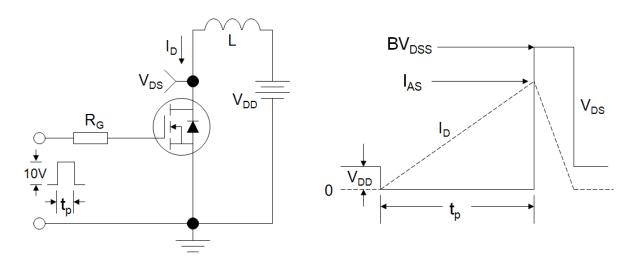
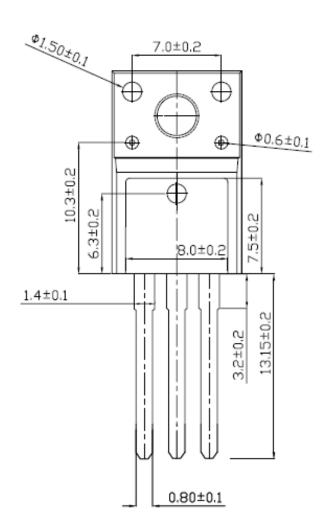


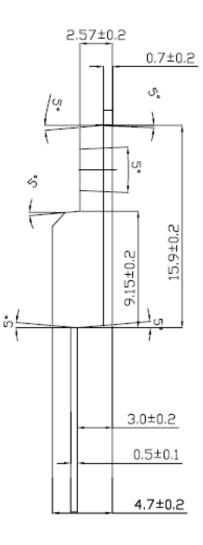
Figure C: Unclamped Inductive Switching Test Circuit and Waveform





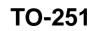
TO-220F

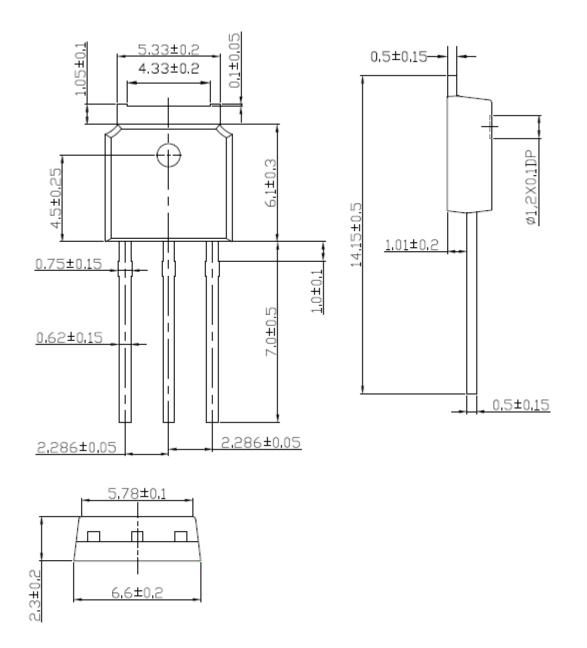




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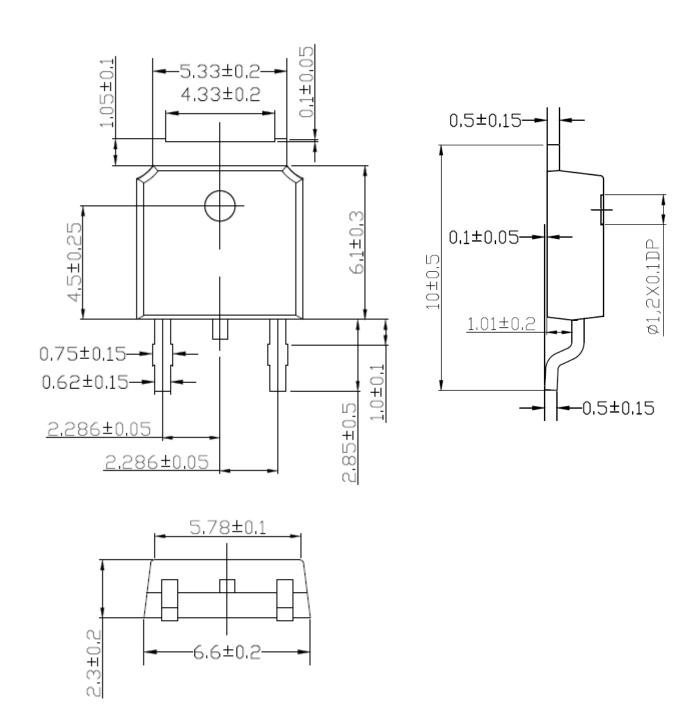








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